

Express Mail Label EV139299654US

INVENTORSHIP DECLARATION BY JOINT INVENTORS

I HEREBY DECLARE THAT:

My residence, mailing address, and citizenship are stated next to my name in PART A hereof.

I believe I am the original, first, and joint inventor of the subject matter which is claimed and for which a patent is sought on the invention entitled

APPARATUS AND METHOD FOR ELECTROLYTICALLY DEPOSITING COPPER ON A SEMICONDUCTOR WORKPIECE

the specification of which:

☐ is attached hereto.

☒ was filed on November 22, 2002 as Application Serial No. 10/302,711.

I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the examination of this application in accordance with 37 CFR §1.56, including, for continuation-in-part applications, material information which became available between the filing date of the prior application and the national or PCT international filing date of the continuation-in-part application.

I hereby claim priority benefits under 35 USC §119(a)-(d) or (f), §172, or §365(a)-(b) of any foreign or international application(s) for patent or inventor's certificate listed in PART B hereof and have also identified in PART B hereof any such foreign or international application having a filing date before that of the application of which priority is claimed.

I hereby declare that all statements made herein of my knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon. I understand that the execution of this document does not in itself establish an attorney-client relationship between the undersigned and Perkins Coie, LLP, or any of its attorneys.

See page 2 attached, signed, and made a part hereof.


INVENTORSHIP DECLARATION BY JOINT INVENTORS

PART A: INVENTOR INFORMATION AND SIGNATURE

Full name of FIRST inventor: Linlin Chen

Citizenship: ~~U.S.~~ Canada Mailing Address: 3213 Placid Springs Lane
D.C. Plano, TX 75025

Residence (if different): _____

Inventor's Signature:  Date: 2/10/2003

Full name of SECOND inventor: Thomas Taylor

Citizenship: U.S. Mailing Address: 308 SW Montgomery Street #206
Portland, OR 97201

Residence (if different): _____

Inventor's Signature: _____ Date: _____

INVENTORSHIP DECLARATION BY JOINT INVENTORS

**PART B: CLAIM TO PRIORITY OF FOREIGN APPLICATION(S) UNDER 35 U.S.C. 119(a-d)
and (f) §172, or §365(a)-(b)**

Country	App. No.	Filing Date	Priority Not Claimed
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Full name of FIRST inventor: Linlin Chen

Citizenship: U.S. Mailing Address: 3213 Placid Springs Lane
Plano, TX 75025


Residence (if different): _____

Inventor's Signature: _____ Date: _____

Full name of SECOND inventor: Thomas Taylor

Citizenship: U.S. Mailing Address: 308 SW Montgomery Street #206
Portland, OR 97201
5223 HENRIETTA BLVD., WESTBOROUGH MA 01581

Residence (if different): _____

Inventor's Signature:  Date: April 25, 2003

(11)
4/25/03

INVENTORSHIP DECLARATION BY JOINT INVENTORS

PART B: **CLAIM TO PRIORITY OF FOREIGN APPLICATION(S) UNDER 35 U.S.C. 119(a-d)**
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Country	App. No.	Filing Date	Priority Not Claimed
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